



S&H Form: (02/05)

**REPLY/AMENDMENT
FEE TRANSMITTAL**

Attorney Docket No.	1186.1033
Application Number	10/808,502
Filing Date	March 25, 2004
First Named Inventor	Takehito TSUKAMOTO et al.
Group Art Unit	2841

AMOUNT ENCLOSED	120.00	Examiner Name	Hoa Cao NGUYEN
-----------------	--------	---------------	----------------

FEE CALCULATION (fees effective 12/08/04)

CLAIMS AS AMENDED	Claims Remaining After Amendment	Highest Number Previously Paid For	Number Extra	Rate	Calculations
TOTAL CLAIMS	36	- 51 =	0	X \$ 50.00 =	\$ 0.00
INDEPENDENT CLAIMS	7	- 12 =	0	X \$ 200.00 =	0.00

Since an Official Action set an original due date of August 26, 2006, petition is hereby made for an extension to cover the date this reply is filed for which the requisite fee is enclosed (1 month (\$120)); (2 months (\$450)); (3 months (\$1,020)); (4 months (\$1,590)); (5 months (\$2,160)).

\$120

If Notice of Appeal is enclosed, add (\$500.00)

If Statutory Disclaimer under Rule 20(d) is enclosed, add fee (\$130.00)

Information Disclosure Statement (Rule 1.17(p)) (\$180.00)

Total of above Calculations = \$ 120.00

Reduction by 50% for filing by small entity (37 CFR 1.9, 1.27 & 1.28)

TOTAL FEES DUE = \$ 120.00

(1) If entry (1) is less than entry (2), entry (3) is "0".

(2) If entry (2) is less than 20, change entry (2) to "20".

(4) If entry (4) is less than entry (5), entry (6) is "0".

(5) If entry (5) is less than 3, change entry (5) to "3".

METHOD OF PAYMENT

- ☒ Check enclosed as payment.
- ☐ Charge "TOTAL FEES DUE" to the Deposit Account No. below.
- ☐ No payment is enclosed.

GENERAL AUTHORIZATION

- ☒ If the above-noted "AMOUNT ENCLOSED" is not correct, the Commissioner is hereby authorized to credit any overpayment or charge any additional fees necessary to:

Deposit Account No. 19-3935

Deposit Account Name STAAS & HALSEY LLP

- ☒ The Commissioner is also authorized to credit any overpayments or charge any additional fees required under 37 CFR 1.16 (filing fees) or 37 CFR 1.17 (processing fees) during the prosecution of this application, including any related application(s) claiming benefit hereof pursuant to 35 USC § 120 (e.g., continuations/divisionals/CIPs under 37 CFR 1.53(b) and/or continuations/divisionals/CPAs under 37 CFR 1.53(d)) to maintain pendency hereof or of any such related application.

SUBMITTED BY: STAAS & HALSEY LLP

Typed Name David J. Cutitta Reg. No. 52,790

Signature

Date

7/26/06

©2005 Staas & Halsey LLP



Attorney Docket No. 1186.1033

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:

Takehito TSUKAMOTO et al.

Application No.: 10/808,502

Group Art Unit: 2841

Confirmation No.: 5712

Filed: March 25, 2004

Examiner: Hoa Cao NGUYEN

For: MULTI-LAYER WIRING BOARD, IC PACKAGE, AND METHOD OF MANUFACTURING
MULTI-LAYER WIRING BOARD

AMENDMENT

Commissioner for Patents
PO Box 1450
Alexandria, VA 22313-1450

Sir:

This is in response to the Office Action mailed May 26, 2006, and having a period for response set to expire on August 26, 2006. A Petition for a one-month extension of time, together with the requisite fee for same, is submitted herewith, thereby extending the period for response to September 26, 2006.

The following amendments and remarks are respectfully submitted. Reconsideration of the claims is respectfully requested.

09/27/2006 SDENB0B1 00000091 10800502

01 FC:1251

120.00 0P